1 • T eSIM (eUICC)

Plastic 2FF/3FF/4FF

TECHNICAL DATA SHEET

Hardware Features

Operating temperature: -25 to +85 °C

Data Retention: 10 years

Erase/Write Cycles: 100.000 cycles

30 Kbytes of User RAM

 Up to 1280 Kbytes of User Flash memory with OTP area

1.8 V, 3 V and 5 V supply voltage ranges

 Current consumption compatible with GSM and ETSI specifications

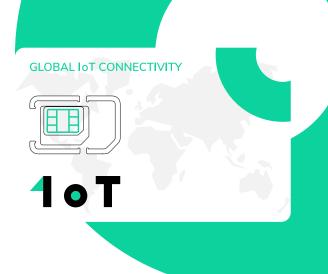
Power-saving standby state

Contact assignment compatible with ISO/IEC 7816-2

ESD protection greater than 4 kV (HBM)

Security Features

- Active shield
- Memory protection unit (MPU)
- Monitoring of environmental parameters
- Protection against faults
- 16- and 32-bit CRC calculation block (ISO 13239, IEEE 802.3, etc.)



- True random number generator
- Hardware security-enhanced
 DES accelerator
- Hardware security-enhanced AES accelerator
- NESCRYPT coprocessor for public key cryptography algorithm

Software features

- 2G/3G Rel12 (U)SIM Main Features
- JavaCard and GlobalPlatform Features
- ISIM Features
- Dynamic Memory Management
- OTA and BIP/CAT-TP Features
- EAP Methods



